



BTM521

Bluetooth Module Data Sheet

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Revision History

| Date | Version | Description | Author |
|------------|---------|---|--------|
| 2012-03-14 | V1.0 | ■ First Release | |
| 2012-05-28 | V1.1 | ■ Update Reference Schematic & Pin Definition | |
| 2012-06-26 | V1.11 | ■ Add UART Port Application Notes | |
| | | | |
| | | | |
| | | | |



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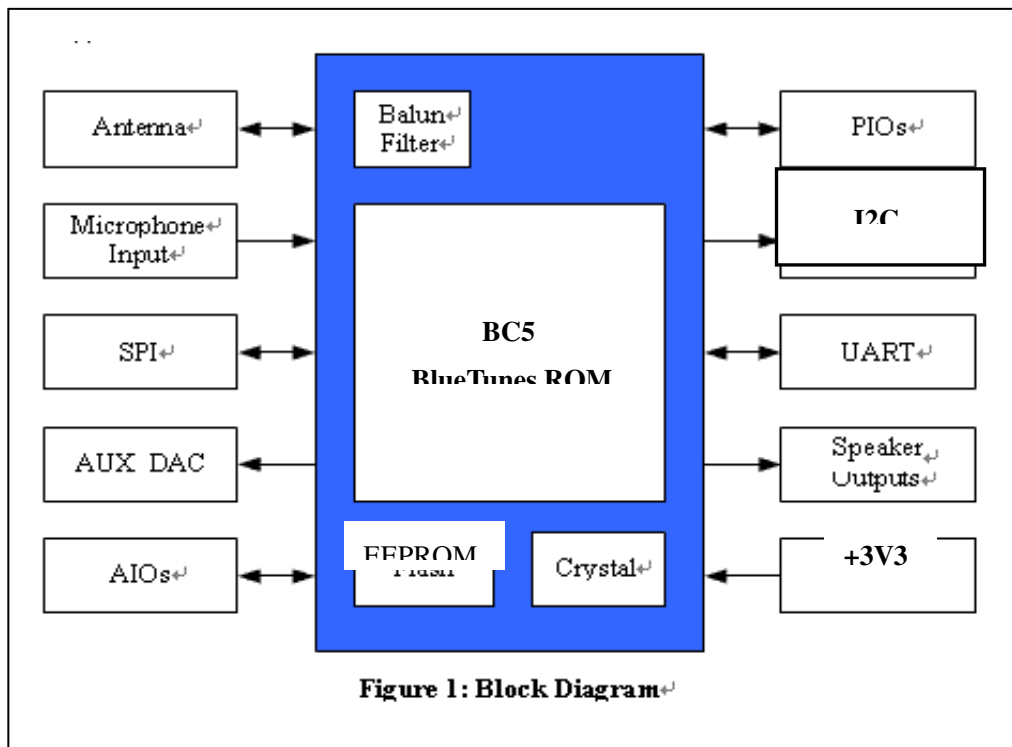
1. INTRODUCTION

The BTM521 Bluetooth® module is a perfect solution for enhanced audio applications, such as stereo headphones. It can be connected with any Bluetooth® devices in an operating range. It is slim and light so the designers can have better flexibilities for the product shapes.

The BTM521 Bluetooth® module complies with Bluetooth® specification version 2.1. It supports HSP, HFP, A2DP, AVRCP profiles. It integrates RF Baseband controller, antenna, etc. and provide UART interface, programmable I/O, stereo speaker output, microphone input,... etc.

The detail information of BTM521 Bluetooth® module is presented in this document below.

1.1 Block Diagram





1.2 Features

- ✓ Small overall dimension(17.6mm x 24mm x 2mm)
- ✓ Bluetooth Specification V2.1 + EDR
- ✓ Class 1, Class 2 and Class 3 support
- ✓ Physical connection as SMD type
- ✓ DSP Co-Processor 16-bit Internal Stereo CODEC for DAC.
- ✓ High quality stereo audio
- ✓ Music Enhancements: SBC,MP3,FastStream(low-latency codec) and 5-band EQ
- ✓ Built-in RF combo filter, Integrated 26M Crystal.
- ✓ Support HSP, HFP, A2DP, AVRCP profile.
- ✓ Compatible with CSR cVc software echo cancellation solution.
- ✓ No radio signal interference, support for 802.11 co-existence
- ※ *Some features are optional for customization on demand.*



1.3 Application

- ✓ High Quality Stereo Bluetooth Headsets
- ✓ High Quality Wired Stereo Headset and Headphones
- ✓ Bluetooth Speakers



2. GENERAL SPECIFICATION

| Bluetooth Specification | |
|-------------------------|---|
| Chip Set | BC5(BlueTunes ROM) |
| Module ID | BTM521 |
| BT Standard | Bluetooth® V2.1 + EDR specification |
| RF TX Output Power | 4dBm (Class II) |
| Sensitivity | -82dBm@0.1%BER |
| Frequency Band | 2.402GHz~2.480GHz ISM Band |
| Baseband Crystal OSC | 26MHz |
| Hopping | 1600hops/sec, 1MHz channel space |
| RF Input Impedance | 50 ohms |
| Major Interface | <ul style="list-style-type: none">● Microphone : Input (Differential)● Speaker : Output (Differential)● UART : Tx/Rx● PIOs● Antenna |
| Profile | HSP, HFP, A2DP, AVRCP |
| Voice Processor | 64MIPS Kalimba with cVc support |
| Power | |
| Supply Voltage | 3.3V ~ 4.2V DC |
| Working Current | 35mA typical, Depends on profiles |
| Standby Current | <1mA |
| Operating Environment | |
| Temperature | -20°C to +70°C |
| Humidity | 10%~90% Non-Condensing |
| Environmental | RoHS Compliant |



3. PHYSICAL CHARACTERISTIC

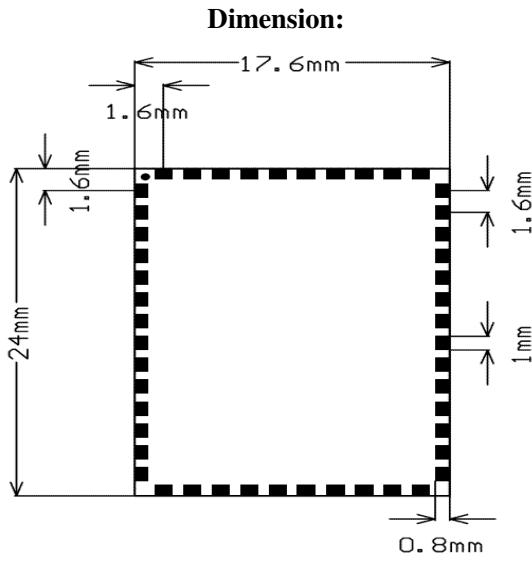


Figure 2

Top View:

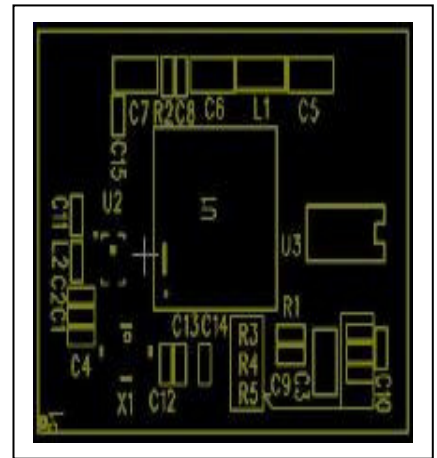


Figure 3

Pin Definition:

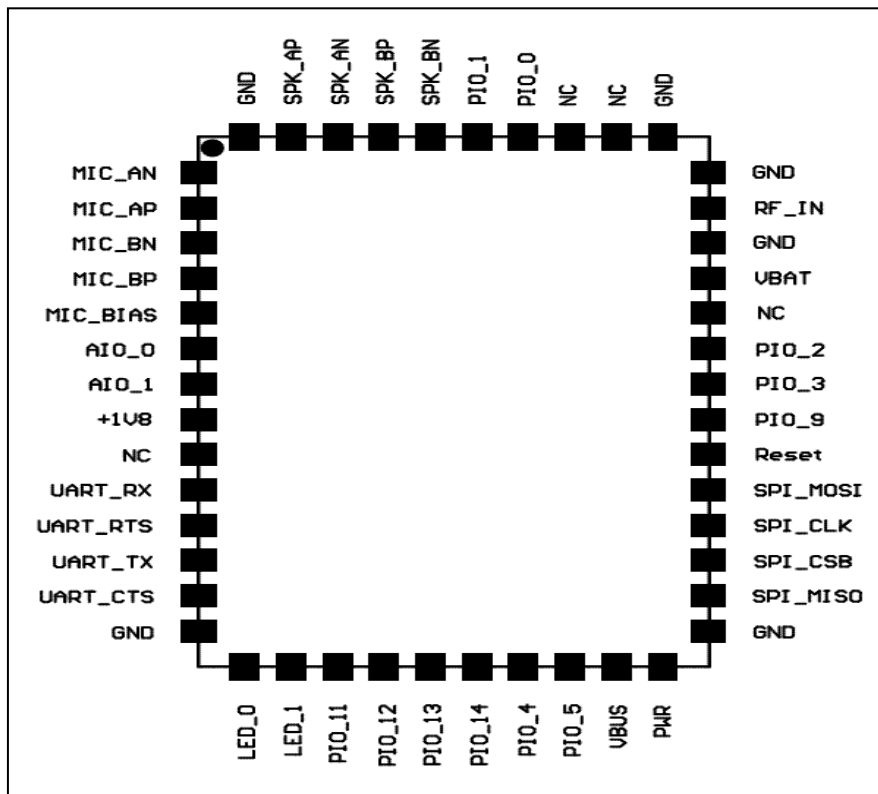


Figure 4



3.1 Pin Description

| Pin# | Pin Name | Pad Type | Description |
|------|----------|---|--|
| 1 | MIC_AN | Analogue | Microphone input negative, left |
| 2 | MIC_AP | Analogue | Microphone input positive, left |
| 3 | MIC_BN | Analogue | Microphone input negative, right |
| 4 | MIC_BP | Analogue | Microphone input positive, right |
| 5 | MIC_BIAS | Analogue | Microphone bias |
| 6 | AIO_0 | Bi-directional VDD/Low-voltage regulator output | Analogue programmable input/ output line circuitry and 1.5V regulated output (from internal low-voltage regulator) |
| 7 | AIO_1 | Bi-directional VDD/Low-voltage regulator output | Analogue programmable input/ output line circuitry and 1.5V regulated output (from internal low-voltage regulator) |
| 8 | +1V8 | Power | High-voltage linear regulator output (1.8V out) |
| 9 | NC | NC | NC |
| 10 | UART_RX | CMOS input with weak internal pull-down | UART data input |
| 11 | UART_RTS | Bi-directional CMOS output, tri-state, with weak internal pull-up | UART request to send active low |
| 12 | UART_TX | Bi-directional CMOS output, tri-state, with weak internal pull-up | UART data output |
| 13 | UART_CTS | CMOS input with weak internal pull-down | UART clear to send active low |
| 14 | GND | Ground | Digital Ground |
| 15 | LED_0 | Open drain output | LED driver |
| 16 | LED_1 | Open drain output | LED driver |
| 17 | PIO_11 | Bi-directional with programmable strength internal pull-up/down | Programmable input/output line |
| 18 | PIO_12 | Bi-directional with programmable strength internal pull-up/down | Programmable input/output line |
| 19 | PIO_13 | Bi-directional with programmable strength internal pull-up/down | Programmable input/output line |
| 20 | PIO_14 | Bi-directional with programmable | Programmable input/output line |



| | | | |
|----|----------|---|---|
| | | strength internal pull-up/down | |
| 21 | PIO_4 | Bi-directional with programmable strength internal pull-up/down | Programmable input/output line |
| 22 | PIO_5 | Bi-directional with programmable strength internal pull-up/down | Programmable input/output line |
| 23 | VBUS | Charger input | Lithium ion/polymer battery charger input (4.5V~6.5V) |
| 24 | PWR | Analogue | Take high to enable high-voltage linear regulator and switch-mode regulator |
| 25 | GND | Ground | Digital Ground |
| 26 | SPI_MISO | CMOS output, tri-state, with weak internal pull-down | SPI data output |
| 27 | SPI_CSB | Input with weak internal pull-up | Chip select for Serial Peripheral Interface (SPI),active low |
| 28 | SPI_CLK | Input with weak internal pull-down | SPI clock |
| 29 | SPI_MOSI | CMOS input, with weak internal pull-down | SPI data input |
| 30 | Reset | Input with weak internal pull-up | Input debounced so must be low for >5ms to cause a reset. |
| 31 | PIO_9 | Bi-directional with programmable strength internal pull-up/down | Programmable input/output line |
| 32 | PIO_3 | Bi-directional with programmable strength internal pull-up/down | Programmable input/output line |
| 33 | PIO_2 | Bi-directional with programmable strength internal pull-up/down | Programmable input/output line |
| 34 | NC | NC | NC |
| 35 | VBAT | VDD | Positive supply for BT Module(3.3V~4.2V) |
| 36 | GND | Ground | Digital Ground |
| 37 | RF_IO | RF | RF out |
| 38 | GND | Ground | Digital Ground |
| 39 | GND | Ground | Digital Ground |
| 40 | NC | NC | NC |
| 41 | NC | NC | NC |



| | | | |
|----|--------|---|--------------------------------|
| 42 | PIO_0 | Bi-directional with programmable strength internal pull-up/down | Programmable input/output line |
| 43 | PIO_1 | Bi-directional with programmable strength internal pull-up/down | Programmable input/output line |
| 44 | SPK_BN | Analogue | Speaker output negative, right |
| 45 | SPK_BP | Analogue | Speaker output positive, right |
| 46 | SPK_AN | Analogue | Speaker output negative, left |
| 47 | SPK_AP | Analogue | Speaker output positive, left |
| 48 | AGND | Analogue | Analogue ground |



4. REFERENCE SCHEMATIC

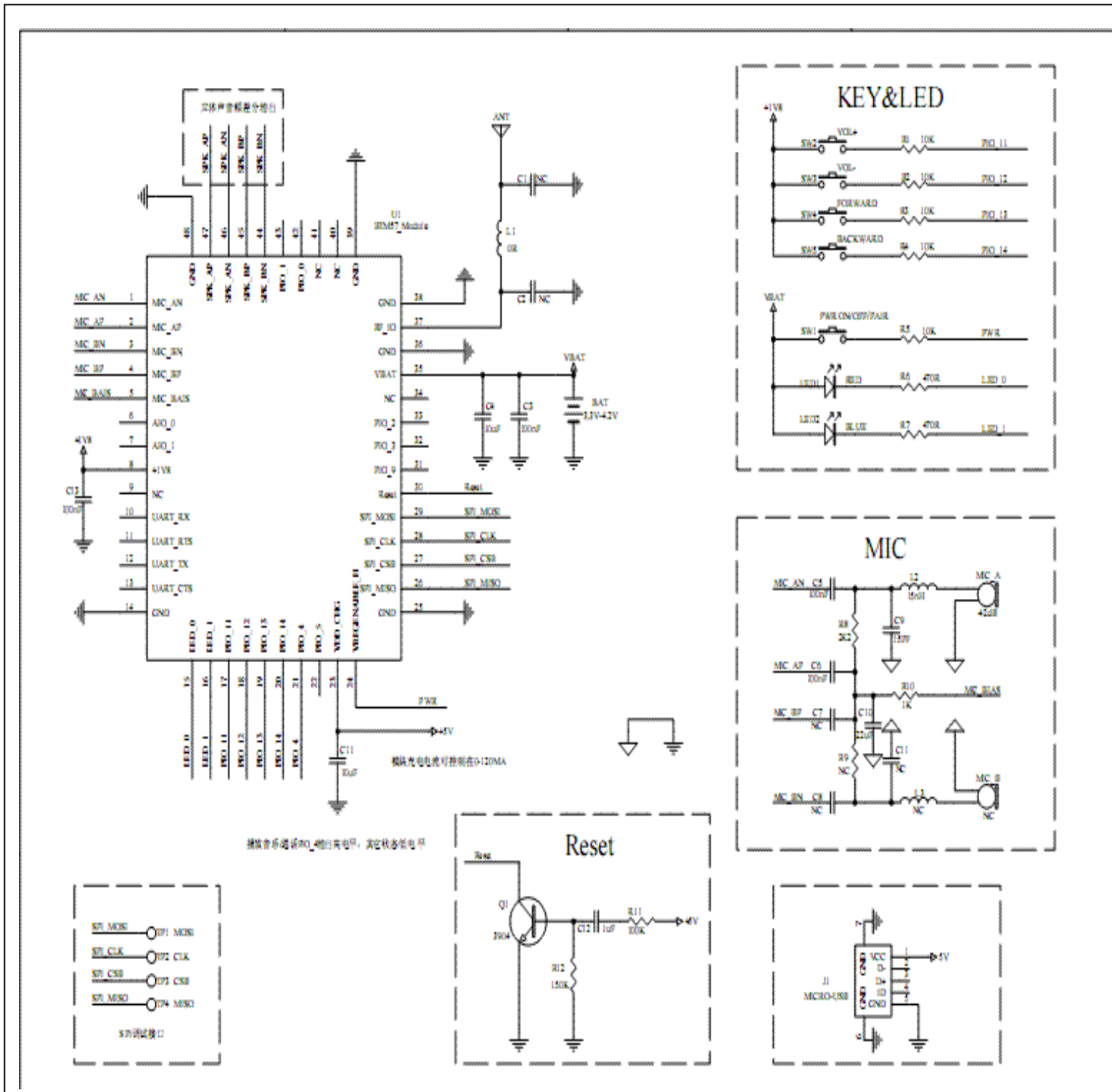


Figure 5



5. PHYSICAL INTERFACE

5.1 Power Supply

The transient response of the regulator is important. If the power rails of the module are supplied from an external voltage source, the transient response of any regulator used should be 20µs or less.

5.2 Audio Interfaces

Audio interface as following features:

- Mono analogue input for voice band and audio band
- Stereo and mono analogue output for voice band and audio band

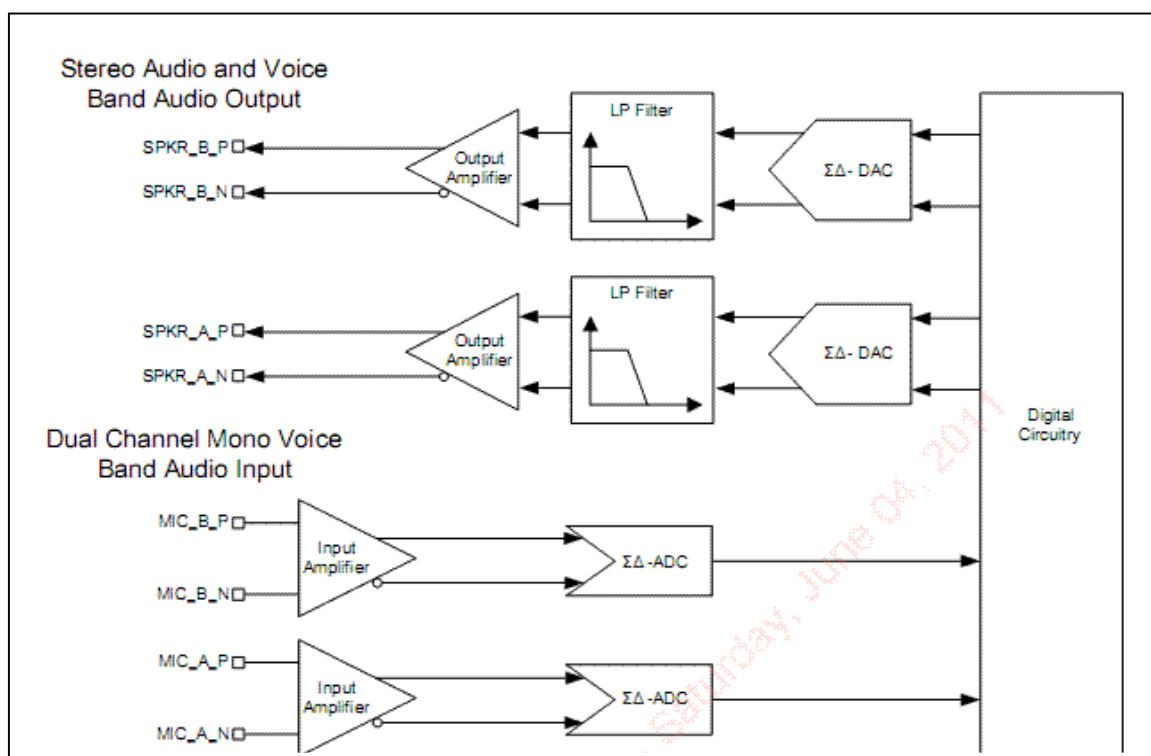


Figure 6

The stereo audio CODEC uses a fully differential architecture in the analogue signal path, which results in low noise sensitivity and good power supply rejection while effectively doubling the signal amplitude. It uses a minimum of external components. The module features a differential stereo audio output interfaces.

5.2.1 ADC

The ADC consists of a second order Digma Delta converter as show in Figure 6.



5.2.2 ADC Sample Rate Selection and Warping

ADC supports the following sample rates: 8kHz, 11.025kHz, 16kHz, 22.05kHz, 24kHz, 32kHz, 44.1kHz, 48kHz.

One of the main concerns for stereo wireless music applications is the ability to keep sample rates for the CODECs at both ends of the wireless link in synchronization. A VM function adjusts the sample rate using a ‘warping’ function to tune the sample rate to the required value. The ADC warp function allows the sample rate to be changed by +/-3%, in steps of $1/2^{17}$, or 7.6ppm. The warp function preserves the signal quality – the distortion introduced when warping the sample rate is negligible.

5.2.3 ADC Gain

The ADC contains two gain stages for each channel, an analogue and a digital gain stage.

5.2.4 DAC

The DAC contains two second order Sigma Delta converters allowing two separate channels that are identical in functionality as show in **Figure 6**.

5.2.5 DAC Sample Rate Selection and Warping

Each DAC supports the following sample rates: 8kHz, 11.025kHz, 16kHz, 22.05kHz, 24kHz, 32kHz, 44.1kHz, 48kHz, 96kHz.

One of the main concerns for the DAC used in stereo wireless music applications is the ability to keep sample rates for the CODECs at both ends of the wireless link in synchronization. A VM function adjusts the sample rate using a ‘warping’ function to tune the sample rate to the required value. The ADC warp function allows the sample rate to be changed by +/-3%, in steps of $1/2^{17}$, or 7.6ppm. The warp function preserves the signal quality – the distortion introduced when warping the sample rate is negligible.

5.2.6 DAC Gain

The DAC contains two gain stages for each channel, a digital and an analogue gain stage.

5.2.7 Mono Operation

Mono operation is single channel operation of the stereo CODEC. The left channel represents the single mono channel for audio in and audio out. In mono operation the right channel is auxiliary mono channel that may be used in dual mono channel operation.



5.2.8 Audio Input Stage

The audio input stage of the module consists of a low noise input amplifier, which receives its analogue input signal from pins MIC_AP and MIC_AN to a second-order Σ - Δ ADC that outputs a 4Mbit/sec single-bit stream into the digital circuitry. The input can be configured to be either single ended or fully differential. It can be programmed for either microphone or line input and has a 3-bit digital gain setting of the input-amplifier in 3dB steps to optimize it for the use of different microphones.

5.2.9 Microphone Input

Check the reference design in **Figure 6** for the microphone input design.

5.2.10 Audio Output Stage

The output digital circuitry converts the signal from 16-bit per sample, linear PCM of variable sampling frequency to a 2Mbits/sec multi-bit stream, which is fed into the analogue output circuitry.

The output circuit comprises a digital to analogue converter with gain setting and output amplifier. Its class-AB output-stage is capable of driving a signal on both channels of up to 2V_{pk-pk}- differential into a load of 16 Ω . The output is available as a differential signal between SPK_AP and SPK_AN for the left channel; and between SPK_BP and SPK_BN for the right channel. The output is capable of driving a speaker directly if its impedance is at least 8 Ω if only one channel is connected or an external regulator is used.

The gain of the output stage is controlled by a 3-bit programmable resistive divider, which sets the gain in steps of approximately 3dB.

The multi-bit stream from the digital circuitry is low pass filtered by a second order bi-quad filter with a pole at 20kHz. The signal is then amplified in the fully differential output stage, which has a gain bandwidth of typically 1MHz.

5.3 RF Interface

The module integrates a balun filter. The user can connect a 50ohms antenna directly to the RF port.

5.4 General Purpose Analog IO

The general purpose analog IOs can be configured as ADC inputs by software. Do not connect them if not use.

5.5 General Purpose Digital IO

There are nine general purpose digital IOs defined in the module. All these GPIOs can be configured by software to realize various functions, such as button controls, LED displays or interrupt signals to host controller, etc. Do not connect them if not use.



5.6 Serial Interfaces

5.6.1 UART

This is a standard UART interface for communicating with other serial devices. The UART interface provides a simple mechanism for communicating with other serial devices using the RS232 protocol.

When the module is connected to another digital device, UART_RX and UART_TX transfer data between the two devices. The remaining two signals, UART_CTS and UART_RTS, can be used to implement RS232 hardware flow control where both are active low indicators.

Note: The serial port interface(UART)can be used for system debugging. Don't support to use command set for profile function application by UART, such as HFP/A2DP/AVRCP and so on. These profiles function application can be controlled only by PIO, such as pairing/connect/answer/play/pause/next/previous function application and so on.

5.6.2 SPI

The synchronous serial port interface (SPI) can be used for system debugging. It can also be used for in-system programming for the flash memory within the module. SPI interface uses the SPI_MOSI, SPI_MISO, SPI_CSB and SPI_CLK pins. Testing points for the SPI interface are reserved on board in case that the firmware shall be updated during manufacture.

The module operates as a slave and thus SPI_MISO is an output of the module. SPI_MISO is not in high-impedance state when SPI_CSB is pulled high. Instead, the module outputs 0 if the processor is running and 1 if it is stopped. Thus the module should NOT be connected in a multi-slave arrangement by simple parallel connection of slave SPI_MISO lines.

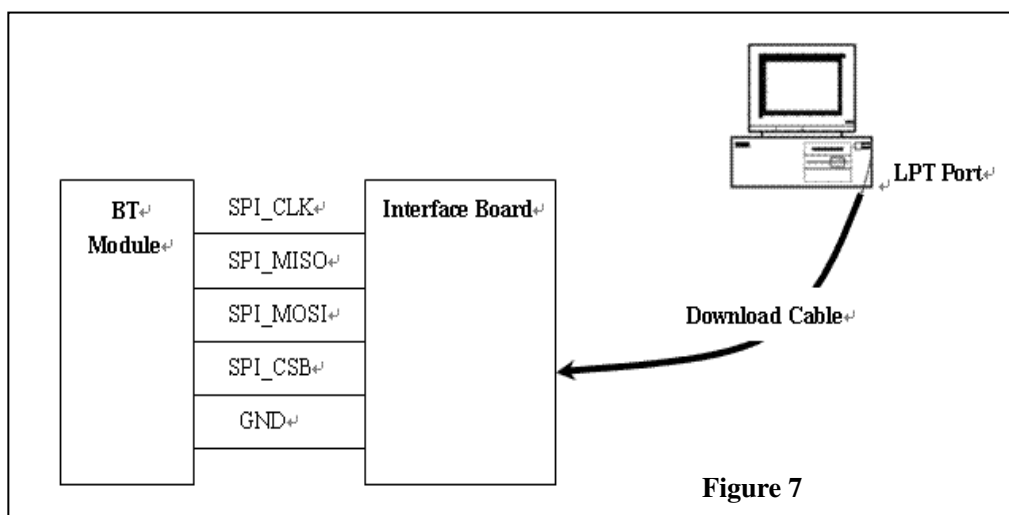


Figure 7



6. ELECTRICAL CHARACTERISTIC

6.1 Absolute Maximum Rating

| Rating | Min | Max | Unit |
|-----------------------------------|------|----------|------|
| Storage Temperature | -40 | +105 | °C |
| Operating Temperature | -20 | +70 | °C |
| PIO/AIO Voltage | -0.4 | +1.8 | V |
| VBAT Voltage | -0.4 | +3.6 | V |
| USB_DP/USB_DN Voltage | -0.4 | +3.6 | V |
| Other Terminal Voltages except RF | -0.4 | VBAT+0.4 | V |

Table 1

6.2 Recommended Operating Conditions

| Operating Condition | Min | Typical | Max | Unit |
|-----------------------------|------|---------|------|------|
| Operating Temperature Range | -20 | -- | +70 | °C |
| VBAT Voltage | +3.0 | +3.3 | +4.2 | V |

Table 2

6.3 Input/output Terminal Characteristics

6.3.1 Digital Terminals

| Supply Voltage Levels | Min | Typical | Max | Unit |
|--|------------|---------|------------|------|
| Input Voltage Levels | | | | |
| V _{IL} input logic level low | -0.3 | - | +0.25xVBAT | V |
| V _{IH} input logic level high | 0.625*VBAT | - | VBAT+0.3 | V |
| Output Voltage Levels | | | | |
| V _{OL} output logic level low, I _{OL} = 4.0mA | - | - | 0.125 | V |
| V _{OH} output logic level high, I _{OH} = -4.0mA | 0.75xVBAT | - | 0.625xVBAT | V |
| Input and Tri-state Current | | | | |
| I _i input leakage current at V _{in} =+3V3 or 0V | -100 | 0 | 100 | nA |
| I _{oz} tri-state output leakage current at V _o =+3V3 or 0V | -100 | 0 | 100 | nA |
| With strong pull-up | -100 | -40 | -10 | μA |
| With strong pull-down | 10 | 40 | 100 | μA |
| With weak pull-up | -5 | -1.0 | -0.2 | μA |
| With weak pull-down | 0. | +1. | 5.0 | μA |
| I/O pad leakage current | -1 | 0 | +1 | μA |



| | | | | |
|---|------|---|-----|----|
| CI Input Capacitance | 1. | - | 5.0 | pF |
| Resistive Strength | | | | |
| Rpuw weak pull-up strength at +3V3-0.2V | 500k | - | 2M | Ω |
| Rpdw weak pull-up strength at 0.2V | 500k | - | 2M | Ω |
| Rpus strong pull-up strength at +3V3-0.2V | 10k | - | 50k | Ω |
| Rpds strong pull-up strength at 0.2V | 10k | - | 50k | Ω |

Table 3

6.3.2 Internal CODEC - Analogue to Digital Converter

| Parameter | Min | Typical | Max | Unit |
|--|-----|---------|------|------|
| Resolution | - | - | 16 | Bits |
| Input Sample Rate | 8 | - | 44.1 | kHz |
| Signal / Noise, $f_{in}=1\text{kHz}$, $BW=20\text{Hz}->20\text{kHz}$ A-Weighted $\text{THD+N}<1\%$ 150mV Vpk-pk | | | | |
| $F_{\text{sample}} = 8\text{kHz}$ | - | 82 | - | dB |
| $F_{\text{sample}} = 11.025\text{kHz}$ | - | 81 | - | dB |
| $F_{\text{sample}} = 16\text{kHz}$ | - | 80 | - | dB |
| $F_{\text{sample}} = 22.05\text{kHz}$ | - | 79 | - | dB |
| $F_{\text{sample}} = 32\text{kHz}$ | - | 79 | - | dB |
| $F_{\text{sample}} = 44.1\text{kHz}$ | - | 78 | - | dB |
| Digital Gain | -24 | - | 21.5 | dB |

Table 4

6.3.3 Internal CODEC - Digital to Analogue Converter

| Parameter | Min | Typical | Max | Unit |
|--|-----|---------|------|------|
| Resolution | - | - | 16 | Bits |
| Output Sample Rate, F_{sample} | 8 | - | 48 | kHz |
| Signal / Noise, $f_{in}=1\text{kHz}$, $BW=20\text{Hz}->20\text{kHz}$ A-Weighted $\text{THD+N}<0.01\%$ | | | | |
| $F_{\text{sample}} = 8\text{kHz}$ | - | 95 | - | dB |
| $F_{\text{sample}} = 11.025\text{kHz}$ | - | 95 | - | dB |
| $F_{\text{sample}} = 16\text{kHz}$ | - | 95 | - | dB |
| $F_{\text{sample}} = 22.05\text{kHz}$ | - | 95 | - | dB |
| $F_{\text{sample}} = 32\text{kHz}$ | - | 95 | - | dB |
| $F_{\text{sample}} = 44\text{kHz}$ | - | 95 | - | dB |
| $F_{\text{sample}} = 48\text{kHz}$ | - | 95 | - | dB |
| $F_{\text{sample}} = 96\text{kHz}$ | - | 95 | - | dB |
| Digital Gain | -24 | - | 21.5 | dB |
| Gain Resolution | | 1/32 | | dB |

Table 5



6.3.4 Microphone Input

| Microphone Input | Min | Typical | Max | Unit |
|--|-----|---------|-----|--------|
| Input full scale at maximum gain | - | 4 | - | mV rms |
| Input full scale at minimum gain(differential) | | 800 | - | mV rms |
| Gain | -3 | - | 42 | dB |
| Gain resolution | - | 3 | - | dB |
| Distortion at 1kHz | - | - | -74 | dB |
| 3dB Bandwidth | - | 20 | | kHz |
| Input impedance | - | 6 | | kΩ |
| THD+N(microphone input)@30mV rms input | - | 0.04 | - | % |

Table 6

6.3.5 Speaker Output

| Speaker Driver | Min | Typical | Max | Unit |
|--|-----|---------|-------|--------|
| Output voltage full scale swing (differential) | - | 750 | - | mV rms |
| THD+N 100kΩ load | - | - | 0.01% | % |
| THD+N 16Ω load | - | - | 0.1% | % |
| SNR(Load=16Ω, 0dBFS input relative to | - | 95 | - | dB |

Table 7

6.4 Power consumptions

| Operating Condition | Min | Typical | Max | Unit |
|----------------------------------|-----|---------|-----|------|
| Connected Idle (Sniff 1.28 secs) | | 0.19 | | mA |
| Connected with audio streaming | 30 | 35 | 40 | mA |
| Deep Sleep Idle mode | | 60 | | μA |

Table 8



7. RECOMMENDED TEMPERATURE REFLOW PROFILE

The soldering profile depends on various parameters necessitating a set up for each application. The data here is given only for guidance on solder reflow.



2F

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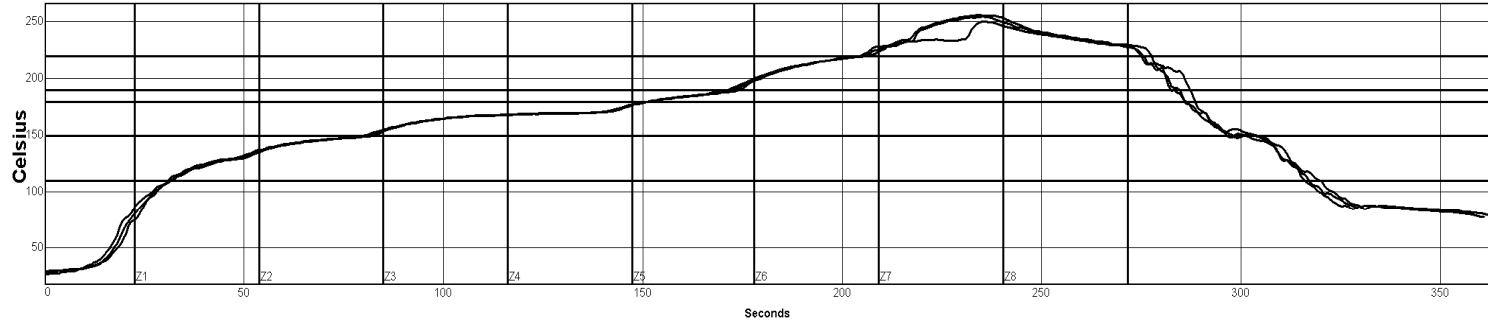
Site:

Process Window Name: 无铅

Oven Name: WQ

| Setpoints (Celsius) | | | | | | | | |
|---------------------|-----|-----|-----|-----|-----|-----|-----|-----|
| Zone | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 |
| Top | 140 | 150 | 170 | 170 | 190 | 225 | 265 | 230 |
| Bottom | 140 | 150 | 170 | 170 | 190 | 225 | 265 | 230 |

Conveyor Speed (cm/min): 75.0



| PWI= 304% | Max Rising Slope | Preheat 110-190C | Soak Time 150-180C | Reflow Time /220C | Peak Temp | | | | | |
|-----------|------------------|------------------|--------------------|-------------------|-----------|-------|------|------|-------|------|
| 2 | 3.9 | 189% | 141.4 | 157% | 70.4 | -296% | 71.1 | 111% | 254.8 | 97% |
| 3 | 4.0 | 197% | 139.7 | 149% | 70.6 | -294% | 70.3 | 103% | 250.6 | 11% |
| 4 | 3.9 | 192% | 142.1 | 160% | 69.6 | -304% | 71.2 | 112% | 256.5 | 130% |

Process Window:

| | | | |
|-------------------------------|-----------|------------|-----------------|
| Solder Paste: SYSTEM DEFAULT | | | |
| Statistic Name | Low Limit | High Limit | Units |
| Max Rising Slope (Target=2.0) | 0.0 | 3.0 | Degrees/Second |
| Preheat Time 110-190C | 90 | 130 | Seconds |
| Soak Time 150-180C | 90 | 110 | Seconds |
| Time Above Reflow - 220C | 50 | 70 | Seconds |
| Peak Temperature | 245 | 255 | Degrees Celsius |

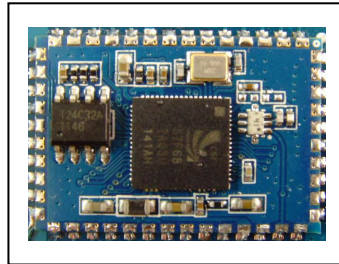
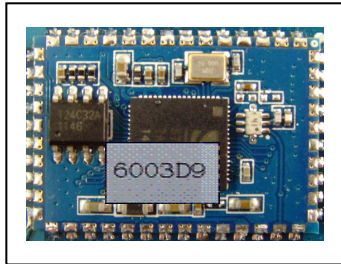
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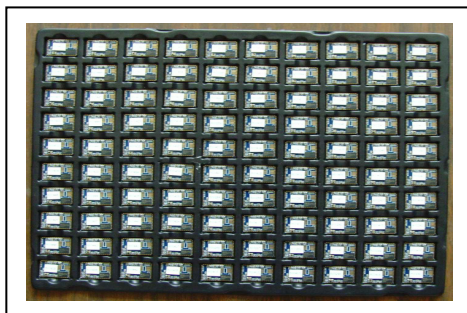


8. PACKAGING INFORMATION

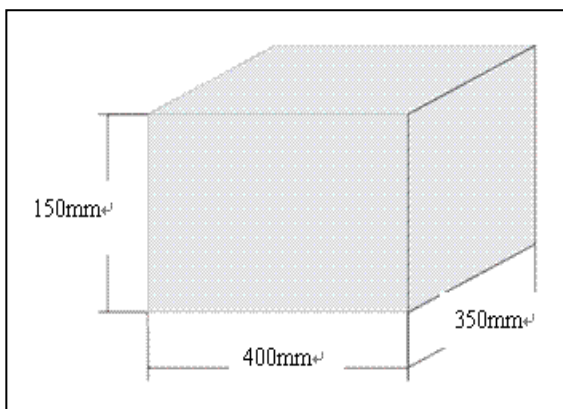
1. BLUETOOTH® Module: BTM521



2. Assembly



3. Dimension



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